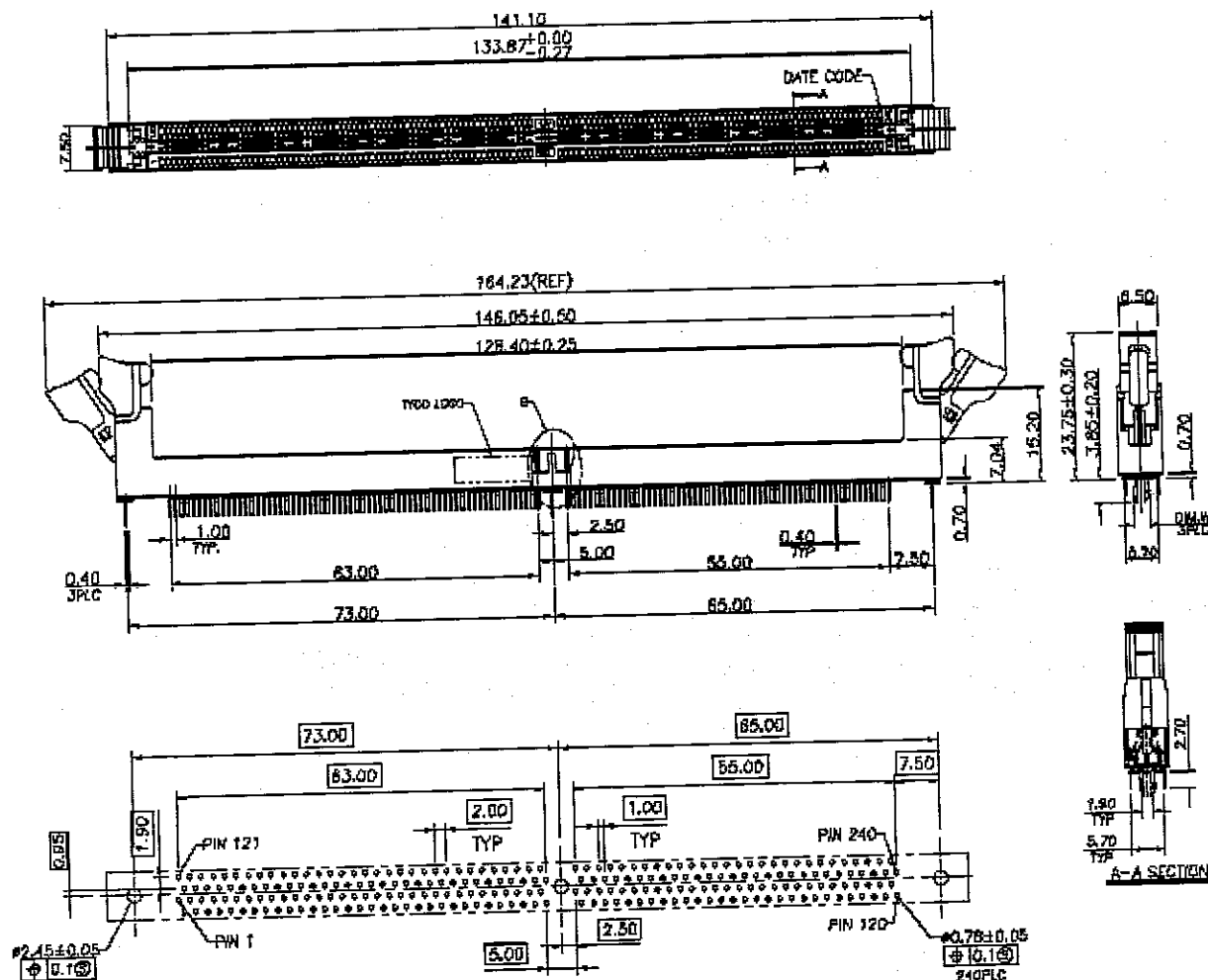


THIS INFORMATION IS CONFIDENTIAL AND IS DISCLOSED TO YOU ON THE CONDITION THAT YOU WILL NOT DISCLOSE IT TO ANY OTHER PERSON OR PERSONNEL WITHOUT THE WRITTEN AUTHORIZATION FROM ARL-70-0000-100.

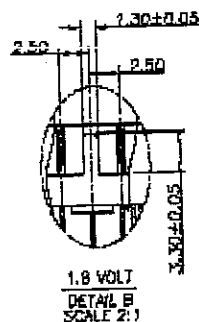
NUMERATIONS IN MILLIMETERS. DO NOT SCALE PRINT.

print: DIST

DW



RECOMMENDED PCB LAYOUT
PCB TOLERANCE: ± 0.05



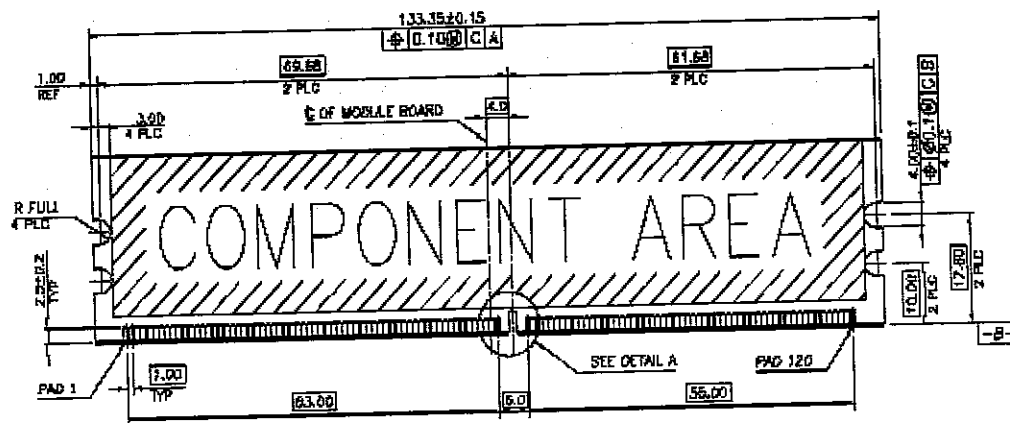
C	ADDED P/MS-3,5,6,7,8,9-1	EDR-06-027568	HH	SH	220007
B	REVISED	EDR-06-007135	SH	WK	234000
A	REVISED	EDR-06-016182	SH	WK	234007
G	FIRST RELEASED	F200-0028-D4	SH	JC	104000
LTH	REVISION RECORD	EDR	SH	CHK	2004
					DATE

NOTES:

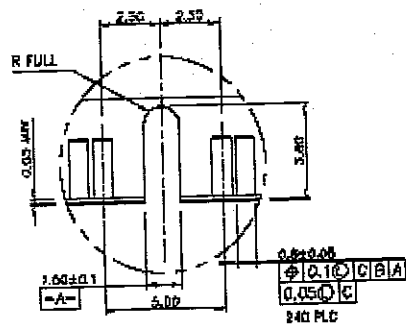
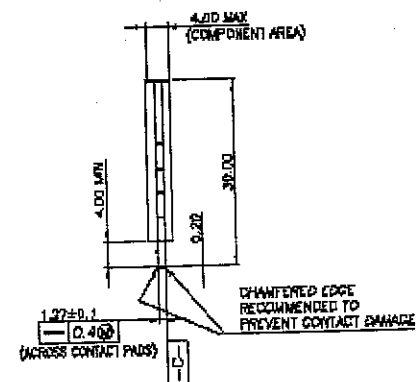
1. MATERIAL:
 - 1.1 HOUSING: THERMOPLASTIC, PA46,
UL94V-0, COLOR: SEE TABLE
 - 1.2 EXTRACTOR: THERMOPLASTIC(PA66),
UL94V-0, COLOR: WHITE
 - 1.3 CONTACT: PHOSPHOR BRONZE
 - 1.4 BOARD LOCK: BRASS
2. FINISH:
 - 2.1 CONTACT:
GOLD PLATING ON CONTACT AREA,
2.54 μ m(100 μ ")MIN. MATTE TIN PLATING ON SOLDER TAILS,
1.27 μ m(50 μ ")MIN. NICKEL UNDERPLATING OVERALL.
 - 2.2 BOARD LOCK:
1.27 μ m(50 μ ") MIN NICKEL UNDERPLATING OVERALL.
3. RECOMMENDED PCB THICKNESS: 1.27mm
4. WAVE SOLDERING CAPABLE TO 265 $\pm$ 5°C,
PER TYCO SPEC. 109-202 CONDITION B.

2.90	GREEN/3258C	GOLD FLASH	8-	-1
	BLUE/2548C	GOLD FLASH	7-	-1
	GREEN 347C	15u"	6-	-4
		GOLD FLASH	6-	-3
	PURPLE 2726U	15u"	8-	-2
		GOLD FLASH	6-	-1
BLUE GREEN 338U	15u"	5-	-2	
	GOLD FLASH	5-	-1	
2.65	ORANGE 137C	15u"	4-	-2
		GOLD FLASH	4-	-1
	APPLE GREEN 382U	15u"	3-	-2
		GOLD FLASH	3-	-1
2.90	BLUE 301C	15u"	2-	-2
		GOLD FLASH	2-	-1
	WHITE	15u"	1-	-2
		GOLD FLASH	1-	-1
	BLACK	30u"		-3
		15u"		-2
GOLD FLASH		1734097-1		
DM. W	HSG. COLDF PANTONE	GOLD PLATING	PART NUMBER	

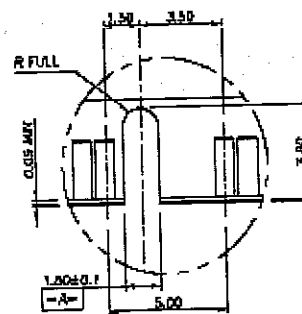
TOLERANCES UNLESS OTHERWISE SPECIFIED		M. HIGASHI 27-NOV-2008		TPOC HOLDING THE PATENT FOR VLSI LTD. TAIWAN BRANCH	
Ø PLD ± 1 PLD ± 0.3 2 PLD ± 0.2 3 PLD ± ANGLES ± 3°		CHK VLSI KE 27-NOV-2008		NAME	
MATERIAL		APVD VLSI KE 27-NOV-2008		DDRII 240PIN SOCKET	
SEE NOTE		PRODUCT SPEC 10B-57350			
FINISH		APPLICATION SPEC -		LOC SEE DW A3	DRAWING NO C-1734097
SEE NOTE		WEIGHT 10 GRAM		SCALE -	SHEET 1 OF 3



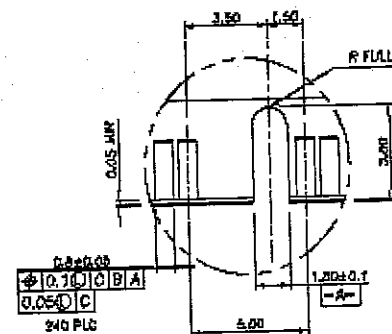
RECOMMENDED MODULE LAYOUT



1.8V
DETAIL A
SCALE 4:1



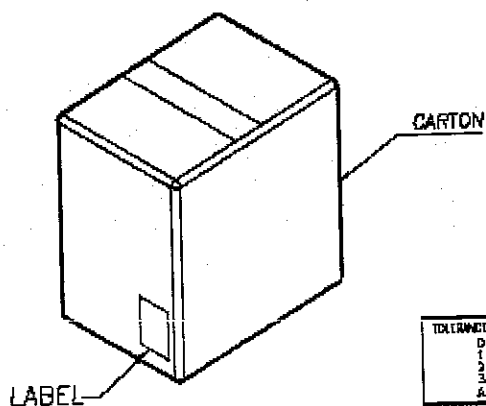
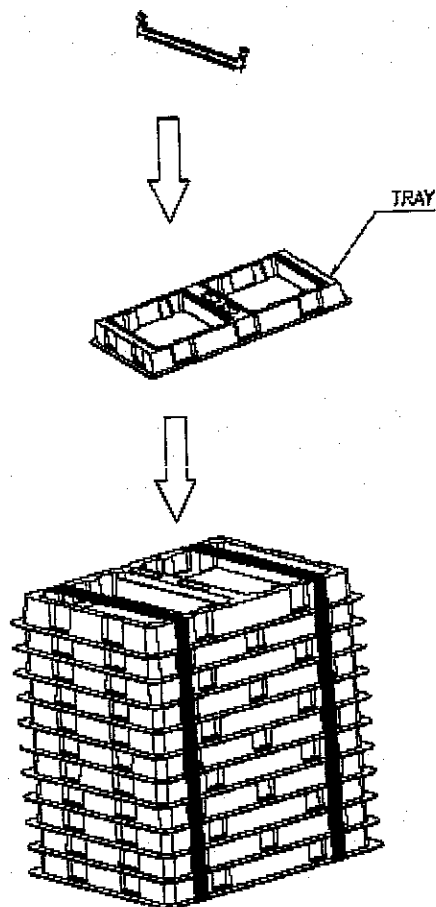
2.5V
DETAIL A
SCALE 4:1



3.3V
DETAIL A
SCALE 4:1

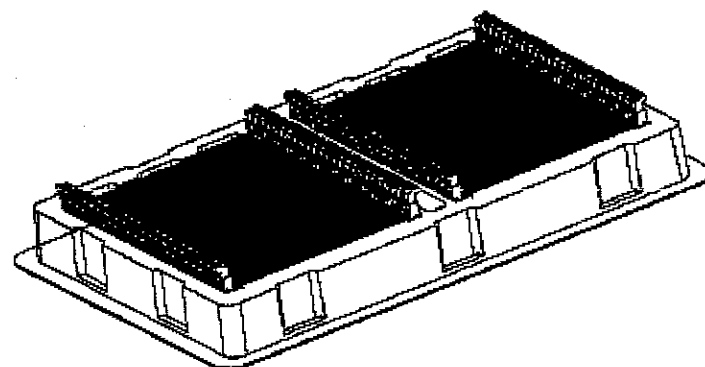
TOLERANCES UNLESS OTHERWISE SPECIFIED:		M. HANSEN 27-NOV-2008		TREC HOLDINGS (MALAYSIA) VI LTD, TAINAN BRANCH	
0 PIC ± 1 PIC ± 0.3 2 PIC ± 0.2 3 PIC ± ANGLES ± 3°		CHK S. HOU 27-NOV-2008		NAME	
MATERIAL		APVD W.J. PE 27-NOV-2008		DDRII 24PIN SOCKET	
		PRODUCT SPEC			
FINISH		APPLICATION SPEC		LOC (SIZE) DRAWING NO. REV DW A3 C-1734097 C	
		WEIGHT		SCALE SHEET	
				— 2 OF 3	

CUSTOMER DRAWING



NOTE:

1. DIMENSION:
TRAY: L = 365, W = 255, H = 33
CARTON: L = 385, W = 270, H = 365
2. QUANTITY:
50 PCS/TRAY
10 TRAYS/CARTON (500 PCS/CARTON)
3. WEIGHT :
NET WEIGHT : 5.0KG
GROSS WEIGHT : 7.0KG



TRAY LAYOUT



LABEL

TOLERANCES UNLESS OTHERWISE SPECIFIED		H. HILANG		Tipe		TIDAK BERTANGGUNG JAWAB	
D PLO ± 0.3		27-NOV-2008		27-NOV-2008		WY LTD. TAINAN BRANCH	
1 PLO ± 0.2		GRK		S. HOU			
3 PLO ± 0.2		27-NOV-2008		27-NOV-2008			
ANGLES ± 3				NAME			
SEE NOTE		APVD		W. A. PE		DDRII 240PIN SOCKET	
		PRODUCT SPEC		27-NOV-2008			
SEE NOTE		APPLICATION SPEC		LOC		SIZE	
		WEIGHT		DW		DRAWING NO	
				SCALE		SHEET	
						3 OF 3	

SEE SHEET 1		ECN		DATE	
LTR		REVISION RECORD		DATE	

CUSTOMER DRAWING

1